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Zener Diode

DZ2W03000L

Panasonic

DZ2W03000L

Silicon epitaxial planar type

For constant voltage / For surge absorption circuit DZ24030 in Mini2 type package

■ Features

- · Excellent rising characteristics of zener current Iz
- · Low zener operating resistance Rz
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: 3J

■ Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

■ Absolute Maximum Ratings Ta = 25 °C

| Parameter | Symbol | Rating | Unit |
|---------------------------------------|--------|-------------|------|
| Repetitive peak forward current | IFRM | 500 | mA |
| Forward current | IF | 200 | mA |
| Total power dissipation *1 | PT | 1 | W |
| Non-repetitive reverse power surge *2 | PZSM | 100 | W |
| Electrostatic discharge *3 | ESD | ±30 | kV |
| Junction temperature | Tj | 150 | °C |
| Operating ambient temperature | Topr | -40 to +85 | °C |
| Storage temperature | Tstg | -55 to +150 | °C |

Note: *1 Mounted on ceramics print circuit board.

Board size: 50 mm × 50 mm Board thickness: 0.8 mm Soldering size: 2 mm × 2 mm

*2 t = 0.1ms

*3 Test method:IEC61000_4_2(C = 150 pF,R = 330 Ω , Contact discharge:10 times)

■ Electrical Characteristics Ta = 25 °C ± 3 °C

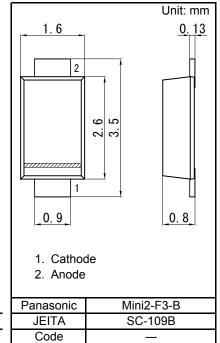
| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|---|--------|-------------|------|------|------|-------|
| Forward voltage | VF | IF = 200 mA | | | 1.2 | V |
| Zener voltage *1, *2 | VZ | IZ = 20 mA | 2.85 | 3.00 | 3.15 | V |
| Zener operating resistance | RZ | IZ = 20 mA | | | 120 | Ω |
| Reverse current | IR | VR = 1 V | | | 150 | μA |
| Temperature coefficient of zener voltage *3 | SZ | IZ = 20 mA | | -1.7 | | mV/°C |

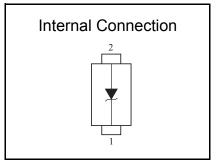
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
 - 2. Absolute frequency of input and output is 5 MHz.
 - *1 The temperature must be controlled 25°C for VZ mesurement.
 VZ value measured at other temperature must be adjusted to VZ (25°C)
 - *2 VZ guaranted 20 ms after current flow.
 - *3 Tj = 25°C to 150°C

: 2013-05-08

Established: 2011-03-11

Revised

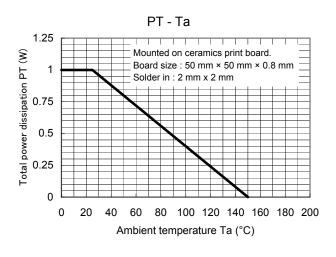


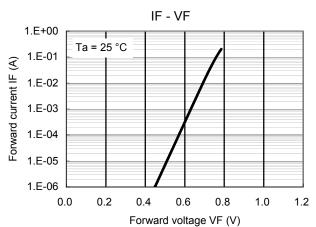


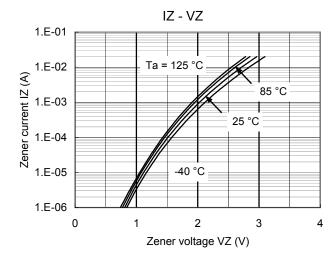
Zener Diode

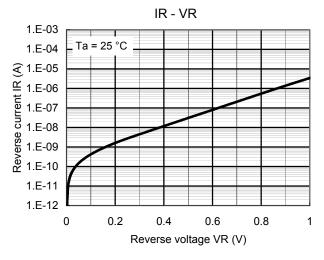
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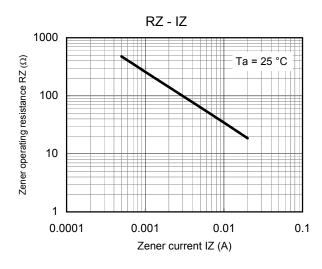
Technical Data (reference)

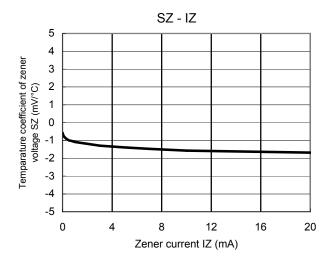












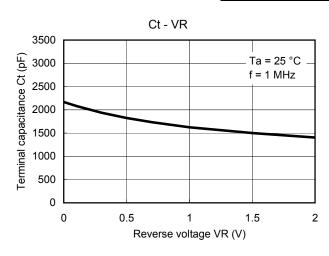
Established: 2011-03-11 Revised: 2013-05-08

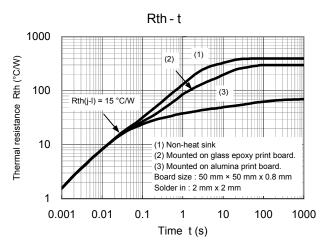
Panasonic

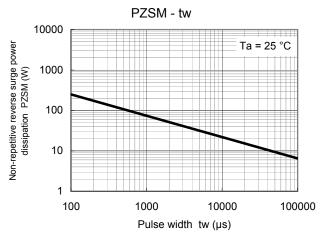
Zener Diode

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Technical Data (reference)







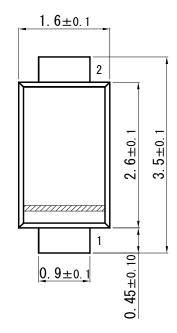
Established: 2011-03-11 Revised: 2013-05-08 **Panasonic**

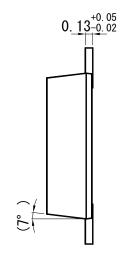
Zener Diode

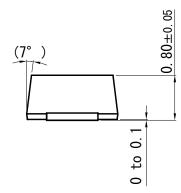
DZ2W03000L

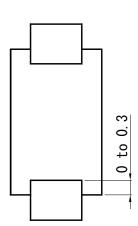
Mini2-F3-B

Unit: mm

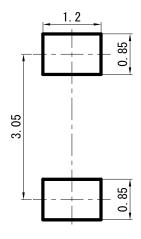








■ Land Pattern (Reference) (Unit: mm)



Established: 2011-03-11 Revised: 2013-05-08

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